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# Thermoelectric power factor of composites

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To improve the performance of thermoelectric materials, a highly effective and widely implemented approach is to create multi-phase composites. These composites are designed to impede phononic heat transport, which accounts for the majority of thermal conductivity in conventional thermoelectric semiconductors. In 1999, Bergman and Fel [J. Appl. Phys. 85(12), 8205-8216 (1999)] reported that also the electronic properties, specifically the power factor  $S^2\sigma$ , can be significantly enhanced in two-phase composites consisting of a highly-conducting, simple metal and a high-performance thermoelectric arranged in an optimal manner, sparking great experimental interest. In this work, we challenge the theoretical results of Bergman and Fel and the conclusions drawn therein by utilizing a simple serial model. We show that, while the improvement of the power factor is indeed extraordinary, the results lead to a misleading interpretation of the overall thermoelectric performance of the material. As a result, we argue that the power factor is not a suitable metric for evaluating multi-phase materials and composites and that the figure of merit  $zT$  must be used instead. Nonetheless, we demonstrate that the best thermoelectric composite consists of a highly conductive metal and a high-performance thermoelectric.

## I. INTRODUCTION

In times of rising energy consumption, there is an increasing demand to use energy more efficiently. One promising solution are thermoelectric materials, which can convert waste heat to electrical energy by making use of the Seebeck effect. The efficiency of such a material is determined by the dimensionless figure of merit  $zT = (S^2\sigma/\lambda)T$ , which is composed of the Seebeck coefficient  $S$ , the electrical conductivity  $\sigma$  and the thermal conductivity  $\lambda$ . Single-phase bulk compounds have been intensively studied over the past decades, resulting in very efficient state-of-the-art materials like  $\text{Bi}_2\text{Te}_3$  [1, 2],  $\text{PbTe}$  [3–5],  $\text{SiGe}$  [6, 7],  $\text{SnSe}$  [8–10], Skutterudites [11–13] or Half-Heusler alloys [14–16] with large figures of merit. Driven by the requirement to decouple thermal and electrical transport in thermoelectric materials, more sophisticated strategies have been employed such as the synthesis of nano-wires [17, 18], thin films [19, 20] as well as nano-structured materials and multi-phase composites [21–24]. For composites comprising different materials or structures, effects like a reduction of the lattice thermal conductivity from increased phonon scattering at defects on various length scales [25–27] and an increase of the Seebeck coefficient due to energy filtering at boundaries [26, 28–30] can significantly increase the thermoelectric performance. However, for these multi-phase materials, a more fundamental question arises: How and to what extent do the thermoelectric properties of the individual constituents contribute towards the overall properties of the composite?

In the 1990s, Bergman *et al.* claimed in two studies that a „high-performance thermoelectric“ and a „benign metal“, *i.e.* a metal with high electrical and thermal conductivity, combined in a favourable spatial configuration, can drastically boost the power factor  $PF = S^2\sigma$  [31] but not the figure of merit  $zT$  [32]. In absence of intrinsic property changes, such as interface effects, this would restrict the potential of composites to a high  $PF$ . Numerous studies have supported the occurrence of a largely enhanced power factor either theoretically or experimentally [33–41]. On the other hand, to the best of our knowledge a debate about the merit of a boosted power factor due to incorporation of a simple metal is still missing.

Here, we inspect the relevant physical processes in composites and elucidate, based on a simple model, why the power factor is seemingly enhanced in such a system, in accord with the calculations by Bergman and Fel [31]. The model largely disregards influences of interfaces on electrical and thermal transport, which are usually present in composites and modify the measured properties. Nevertheless, our results demonstrate that the power factor is misinterpreted in these cases and overestimates the performance of such composite materials. Ultimately, we show in a straightforward manner that the  $PF$  is an ill-defined quantity and performance indicator for the real power output of a material consisting of at least two phases. This will shine a new light on the research of composites and raise the awareness of the ambivalent properties. Lastly, we highlight that, against common intuition, a two-phase heterostructure consisting of a thermoelectric with high  $zT$  and a perfect metal with high electrical and thermal conductivity is nonetheless the optimal thermoelectric composite.

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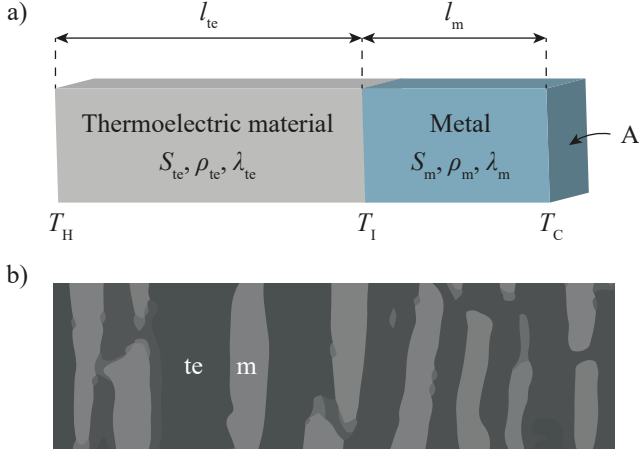


Figure 1. a) Schematic sketch of a serial connection of a thermoelectric material with the length  $l_{te}$  and a metal with the length  $l_m$ . Both materials have individual Seebeck coefficients  $S$ , electrical resistivities  $\rho$  and thermal conductivities  $\lambda$ . The hot temperature at the end of the thermoelectric material, the temperature at the interface and the cold temperature at the end of the metal are denoted as  $T_H$ ,  $T_I$  and  $T_C$ , respectively. b) Sketch of the microstructure for a fictitious thermoelectric composite material with a serial slab configuration.

## II. THERMOELECTRIC PROPERTIES OF A SERIAL THERMOELECTRIC-METAL COMPOSITE

Bergman and Fel calculated the overall thermoelectric properties of thermoelectric-metal composites for several different spatial configurations [31]. They reported that the power factor can be improved through either alternating serial slabs or a spherical structure where the metal is coated by the thermoelectric material. The latter is often a good approximation to more realistic structures, as stated by the authors. In the present study, we will focus on the slab configuration since it is easier to model and provides a better understanding about the origin of the apparent performance changes. Nonetheless, the qualitative similarity between the two configurations [31] allows to extend our results to composites in general.

Fig. 1a shows the model with the respective quantities of the thermoelectric and the metal used to calculate the overall properties. It is similar to the one used by Bergman and Fel, but with only one interface instead of alternating slabs. When ignoring interface effects, as done in both studies, these two models are equivalent. Fig. 1b provides a realistic example for the application of the model in a two-phase composite material.

### A. Power factor

For a better understanding, we will first calculate the total power factor of a serial connection of a thermoelectric material with large  $S$  and an ideal metal with

$\rho_m \rightarrow 0$ , therefore  $\lambda_m \rightarrow \infty$  due to the Wiedemann-Franz law. In the following, the total thermoelectric properties of the composite are written without index. From  $\lambda_m \rightarrow \infty$  of the metal follows that the temperature at the interface  $T_I = T_C$  and the whole temperature drop occurs in the thermoelectric material, yielding the thermovoltage

$$U = S_{te} (T_H - T_C) = S_{te} \Delta T. \quad (1)$$

The total Seebeck coefficient  $S$  is calculated as  $S = U/\Delta T$ , thus

$$S = S_{te}. \quad (2)$$

The total resistance is only comprised of  $\rho_{te}$  due to  $\rho_m = 0$  in the ideal metal, which gives

$$\rho = R_{te} \frac{A}{l_{te} + l_m} = \rho_{te} \frac{l_{te}}{l_{te} + l_m} = \rho_{te} \delta_{te}, \quad (3)$$

with the volume fraction of the thermoelectric material  $\delta_{te}$ . While the Seebeck coefficient is not affected by the metal, the resistivity - obtained by averaging the total resistance over the volume of the entire composite - seemingly decreases due to  $\delta_{te} < 1$ , resulting in an increase of the total power factor:

$$PF = \frac{S^2}{\rho} = \frac{S_{te}^2}{\rho_{te} \delta_{te}} = PF_{te} \frac{1}{\delta_{te}}. \quad (4)$$

Before discussing the physical meaning of Eq. 4, let us examine a more realistic scenario with finite resistivity and Seebeck coefficient ( $S_m \ll S_{te}$ ) in the metal. The temperature differences across the thermoelectric material and the metal,  $\Delta T_{te} = T_H - T_I$  and  $\Delta T_m = T_I - T_m$ , can be calculated from the thermal conductance  $C_i = \lambda_i A / l_i$  of both materials:

$$\Delta T_{te} = \frac{C_m}{C_{te} + C_m} \Delta T = \frac{l_{te} \lambda_m}{l_m \lambda_{te} + l_{te} \lambda_m} \Delta T, \quad (5)$$

$$\Delta T_m = \frac{C_{te}}{C_{te} + C_m} \Delta T = \frac{l_m \lambda_{te}}{l_m \lambda_{te} + l_{te} \lambda_m} \Delta T. \quad (6)$$

Unlike the previous case, the measured thermovoltage now has contributions from both the thermoelectric and the metal and is

$$\begin{aligned} U &= S_{te} \Delta T_{te} + S_m \Delta T_m \\ &= \frac{S_{te} l_{te} \lambda_m + S_m l_m \lambda_{te}}{l_m \lambda_{te} + l_{te} \lambda_m} \Delta T. \end{aligned} \quad (7)$$

This leads to

$$S = \frac{S_{te} l_{te} \lambda_m + S_m l_m \lambda_{te}}{l_m \lambda_{te} + l_{te} \lambda_m}. \quad (8)$$

The total Seebeck coefficient can be written using a material-related quantity  $\varepsilon_\lambda$ , following the notation of

our previous work about the thermoelectric properties of a film-substrate setup [42]:

$$S = \frac{S_{te} + \varepsilon_\lambda S_m}{1 + \varepsilon_\lambda} \quad \text{with} \quad \varepsilon_\lambda = \frac{C_{te}}{C_m} = \frac{l_m \lambda_{te}}{l_{te} \lambda_m}. \quad (9)$$

Depending on the ratio between the individual thermal conductances, the total Seebeck coefficient lies between those of the thermoelectric material and the metal.

The finite resistivity further leads to a contribution of the metal to the total electrical resistance

$$R = R_{te} + R_m = \rho_{te} \frac{l_{te}}{A} + \rho_m \frac{l_m}{A} \quad (10)$$

and thus the electrical resistivity becomes

$$\rho = R \frac{A}{l} = \rho_{te} \left( \delta_{te} + \frac{\rho_m}{\rho_{te}} (1 - \delta_{te}) \right), \quad (11)$$

which is a linear function depending on the volume fraction of the thermoelectric material. By introducing another quantity,

$$\varepsilon_\sigma = \frac{R_m}{R_{te}} = \frac{l_m \rho_m}{l_{te} \rho_{te}}, \quad (12)$$

Eq. 11 can be further simplified to

$$\rho = \rho_{te} \delta_{te} (1 + \varepsilon_\sigma). \quad (13)$$

Combining Eq. 9 and Eq. 11 leads to the total power factor of the system:

$$\begin{aligned} PF &= \frac{S^2}{\rho} \\ &= \left( \frac{S_{te} + \varepsilon_\lambda S_m}{1 + \varepsilon_\lambda} \right)^2 \frac{1}{\rho_{te} \delta_{te} (1 + \varepsilon_\sigma)}. \end{aligned} \quad (14)$$

The different  $\delta_{te}$  dependence of the Seebeck coefficient and electrical resistivity allows for extreme values of the power factor if a well-conducting metal is incorporated into the thermoelectric material. The total power factor can also be written in terms of the individual power factors and the volume fraction of the thermoelectric material:

$$\begin{aligned} PF(\delta_{te}) &= \\ &= \frac{\left( \sqrt{PF_{te}} + \varepsilon_\lambda(\delta_{te}) \sqrt{\frac{\rho_m}{\rho_{te}}} \operatorname{sgn}\left(\frac{S_m}{S_{te}}\right) \sqrt{PF_m} \right)^2}{\delta_{te} (1 + \varepsilon_\lambda(\delta_{te}))^2 (1 + \varepsilon_\sigma(\delta_{te}))} \end{aligned} \quad (15)$$

with the  $\delta_{te}$ -dependent notation of the material-related quantities

$$\varepsilon_\varphi(\delta_{te}) = \frac{\varphi_{te}}{\varphi_m} \left( \frac{1}{\delta_{te}} - 1 \right) \Big|_{\varphi=\lambda, \sigma}. \quad (16)$$

A comparison between Eq. 15 and the results of Bergman and Fel can be observed in Appendix A for three se-

lected systems calculated by the authors. The remarkable agreement between the models validates our assumptions and underscores the significance of the results presented here.

Within the above framework, the presence of a local maximum in  $PF$  depends on whether the decrease in thermovoltage caused by the metal is overcompensated by the increase in electrical conductivity. The consequences and relevance of the resulting  $PF$  enhancement will be discussed later. A comparison between the prediction of Eq. 15 and a  $\text{Fe}_2\text{VAl}_{1.5}\text{-Cu}$  composite is presented in Appendix B.

## B. Figure of merit

Next, we will calculate the figure of merit  $zT$  of a binary composite, starting from an ideal metal with infinite conductivities. The total thermal conductance  $C$  can be calculated, in accordance to the electrical conductance, as

$$\frac{1}{C} = \frac{1}{C_{te}} = \frac{l_{te}}{\lambda_{te} A} := \frac{l_{te} + l_m}{\lambda A} \quad (17)$$

and thus

$$\lambda = \lambda_{te} \frac{1}{\delta_{te}}. \quad (18)$$

The thermal conductivity increases with decreasing volume fraction of the thermoelectric material, similar to the electrical conductivity (see Eq. 3). Combining Eq. 18 and Eq. 4 yields the total figure of merit

$$zT = \frac{PF}{\lambda} T = \frac{PF_{te}}{\lambda_{te}} T = zT_{te}. \quad (19)$$

The total thermal conductivity is modified, when the thermal conductivity of the metal is no longer infinite. It then becomes

$$\frac{1}{C} = \frac{1}{C_{te}} + \frac{1}{C_m} = \frac{l_{te}}{\lambda_{te} A} + \frac{l_m}{\lambda_m A} = \frac{l_{te} + l_m}{\lambda A} \quad (20)$$

$$\lambda = \frac{\lambda_{te}}{\delta_{te} (1 + \varepsilon_\lambda)}. \quad (21)$$

From that a convenient relation of the total figure of merit can be derived:

$$\begin{aligned} zT &= \frac{PF}{\lambda} T \\ &= \frac{\left( \sqrt{zT_{te}} + \sqrt{\varepsilon_\lambda \varepsilon_\sigma} \operatorname{sgn}\left(\frac{S_m}{S_{te}}\right) \sqrt{zT_m} \right)^2}{(1 + \varepsilon_\lambda) (1 + \varepsilon_\sigma)}. \end{aligned} \quad (22)$$

As example we calculated the thermoelectric power factor  $PF$  and figure of merit  $zT$  of a composite consist-

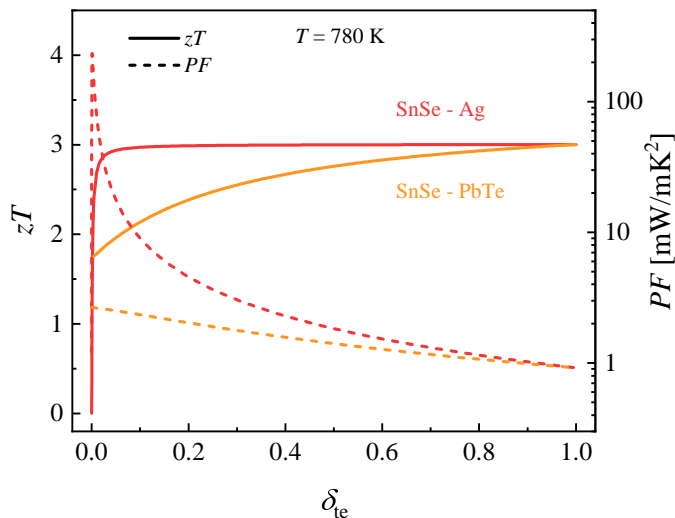


Figure 2. Total figure of merit  $zT$  (solid lines) and power factor (dashed lines) of a serial connection of Na-doped polycrystalline SnSe and Ag (red line) and Se-doped PbTe (orange line) at 780 K in dependence of the volume fraction  $\delta_{\text{te}}$  of SnSe, calculated from Eq. 15 and Eq. 22. The values of the material properties were taken from literature [4, 10, 43–45].

ing of Na-doped polycrystalline SnSe [10] as a high-performance thermoelectric material mixed with elemental Ag as well as another thermoelectric material, Se-doped PbTe [4] (see Fig. 2). While  $PF$  reaches  $\approx 250 PF_{\text{te}}$  in Ag with 0.1% SnSe, the figure of merit in composites differs from the power factor in that a local maximum is absent. Hence, the  $zT$  of the composite always ranges between the values obtained for the pristine material, *i.e.* it is always smaller than the  $zT$  of the thermoelectric. A striking feature in Fig. 2 is that in case of a thermoelectric-metal composite the figure of merit remains nearly constant even at very low volume fractions of the thermoelectric material due to the exceptionally large difference in the electrical and thermal conductivity of both materials. This can be explained by the fact that in a serial configuration most of the temperature difference occurs across the thermoelectric material, preserving the thermovoltage, while the balance between increased electrical and thermal conductivity maintains  $zT$ . Deviation from ideal conduction in the metal is the only factor that decreases the overall  $zT$  (see Eq. 19). In contrast to that, both  $PF$  and  $zT$  of a thermoelectric-thermoelectric composite show a more linear behavior as a function of the volume fraction, revealing the limitation of such systems and necessity of additional effects that truly change the microscopic properties, such as interface scattering or diffusion.

The derivations of the thermoelectric properties presented here neglect interfaces between the constituents of the composite. Interfaces can lead to scattering of charge carriers and phonons and cause a modification of all thermoelectric quantities. Their influence is proportional to the electrical and thermal resistance as well as

the number of interfaces. In Appendix C, a qualitative description of the effect of interfaces is provided. Nevertheless, the statements concluded from the ideal system are still valid if interface scattering is not the dominant mechanism determining the composite’s performance.

### III. CLEARING UP THE DELUSION - MICROSCOPIC VS MACROSCOPIC PERFORMANCE

We point out that resistivity, thermal conductivity and other quantities are material-specific intrinsic properties. In an electrical circuit consisting of several components with different properties - like the composites discussed here - the microscopic definition of the resistivity becomes ill-defined due to spatial inhomogeneity. Likewise, the  $PF$  becomes meaningless, as it does not reflect the total power output any more, as shown below. Instead, the proper quantities to compare the performance of such networks are total power output, heat conductance and resistance. Such macroscopic quantities are generally more robust and less prone to mistakes and misinterpretations since they are measured directly and don’t require considerations about the dimensions and microstructure of the system.

To further elucidate the meaning of the power factor of composites, we will compare  $PF$ ,  $zT$  and the power output for the three different systems comprised of the state-of-the-art thermoelectric material SnSe and elemental Ag, as depicted in Fig. 3a. These include a pure thermoelectric (I), a thermoelectric-metal composite (II) as well as the pure thermoelectric with reduced length (III). Again, interfaces will be neglected, which will yield different results than would be obtained experimentally. However, the informative value of the distinct difference between the setups is still assured.

It is well known that the maximum power transfer to a load connected to a thermoelectric generator occurs for equal resistances [46], thus

$$P_{\text{max}} = \frac{U^2}{4R}, \quad (23)$$

with  $U$  and  $R$  being the total generated thermovoltage and resistance of the composite, respectively. Utilizing the definitions  $U = S\Delta T$ ,  $PF = S^2\sigma$  and  $R = l/(\sigma A)$ , which equals a transformation of the composite into a single „average“ material, Eq. 23 can be rewritten as

$$P_{\text{max}} = \frac{A}{4l} PF^2 \Delta T. \quad (24)$$

In Fig. 3b, the temperature profile of system II is sketched. Unlike in system I and III, where the temperature decreases linearly between the electrodes, the temperature drops mainly along the thermoelectric component (compare Eq. 5 and Eq. 6). The total power factor, figure of merit and power output are shown in

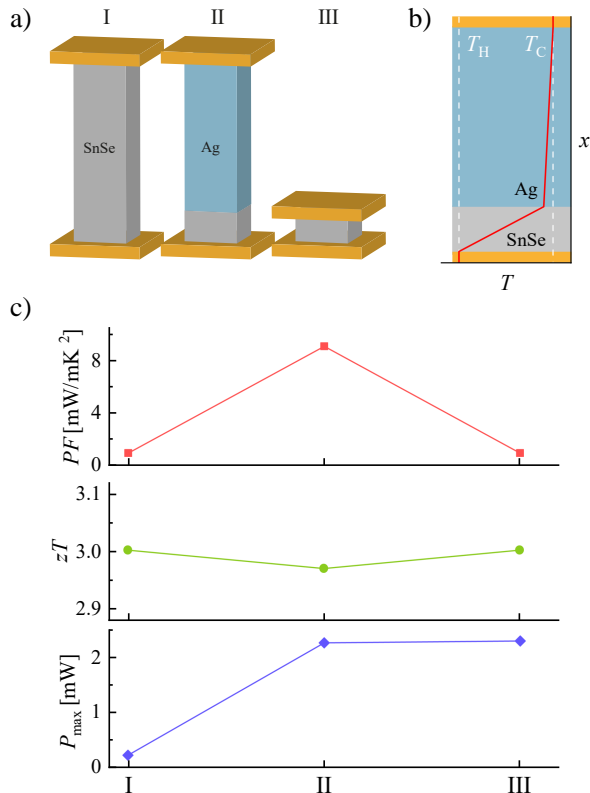


Figure 3. a) Sketch of the three systems compared in the text with respect to their thermoelectric performance. I: (Na-doped polycrystalline) SnSe, II: SnSe-Ag composite with  $\delta_{\text{te}} = 0.1$ , III: SnSe with reduced length similar to system II. b) Temperature profile of system II. c) Power factor, figure of merit and maximum power output for all three systems. The power output was calculated using  $l = 1$  cm,  $A = 1$  mm<sup>2</sup>,  $T = 300$  K and  $\Delta T = 100$  K. For the sake of simplicity, all thermoelectric properties were taken at 780 K [10, 43–45].

Fig. 3c.

On first glance, the SnSe-Ag composite (II) seems to perform better than pure SnSe (I) in terms of power factor and power output, while reducing the figure of merit only moderately. Incorporating metal components into the thermoelectric material improves the power generated by reducing the total resistivity while the Seebeck coefficient  $S$  remains almost unaffected, thereby seemingly decoupling  $S$  and  $\sigma$ , two transport properties which are usually difficult to enhance simultaneously [47]. However, it is not the metal per se that improves the performance but rather the length reduction of the thermoelectric while the temperature drop across the thermoelectric remains the same - an approximation that cannot always be realized in applications. Indeed, a comparison between systems II and III shows that for the same volume of the active thermoelectric component, the power output is marginally higher without the metal despite the fact that the metal composite has a ten times higher power factor. Thus, the enhancement of the power factor found

by several studies and also in the present work merely results from a nonsensical comparison of two materials with different volume fractions of the active thermoelectric component. Therefore, the power factor is no longer a valid indicator for thermoelectric performance in composite materials. Since a large  $PF$  neither indicates a higher  $zT$  nor a higher power output in such composites, the power factor becomes a meaningless parameter for evaluating composite materials or devices. Only in fixed-length setups, if power output is more critical than efficiency, the use of composites can significantly increase power output by reducing the volume fraction of the thermoelectric material and lowering the resistance - given that the same temperature drop can be realized across the thermoelectric material with reduced length, *i.e.* a significantly enhanced temperature gradient  $dT/dl$ .

The showcase presented above nicely illustrates the necessity to consider the dimensions of the material if inhomogeneities are present, as is the case in composites. Accordingly, the use of macroscopic quantities is inevitable.

Another potential application for thermoelectric materials with high power factors is the so-called active cooling, which combines traditional heat conduction with the Peltier effect to enhance cooling capabilities [48]. In this context, a large thermal conductivity and power factor are desired to maximize the effective thermal conductivity  $\lambda_{\text{eff}}$ :

$$\lambda_{\text{eff}} = \left( \lambda + \frac{PF T_H^2}{2\Delta T} \right), \quad (25)$$

with the temperature of the hot side  $T_H$ . Active cooling does indeed look like a promising application when composites are compared to conventional materials (see Appendix D).

However, it is important to examine the macroscopic quantity - the actual cooling power - as the high power factor can be misleading and give a false impression of the performance. A closer look at the cooling power,

$$\frac{dQ}{dt} = \lambda_{\text{eff}} \frac{A}{l} \Delta T = \left( C + \frac{S^2 T_H^2}{2R\Delta T} \right) \Delta T, \quad (26)$$

expressed with the macroscopic quantities  $C = \lambda \frac{A}{l}$  and  $\frac{S^2}{R} = PF \frac{A}{l}$ , reveals the inferiority of composites to pure thermoelectrics. While the resistance can be decreased by substituting part of the thermoelectric material with a metal, thus enhancing the cooling power, the performance is always worse compared to the pure thermoelectric with reduced length. Similar to Eq. 24, the metal-incorporated material appears better due to a comparison of different amount of thermoelectric material.

#### IV. THE BEST COMPOSITE

Before exploring the potential applications of composites, it is important to acknowledge that the formulas



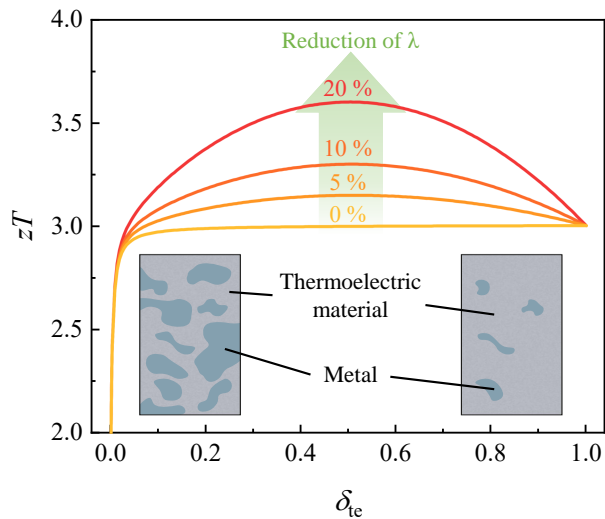


Figure 4. Figure of merit  $zT$  of a SnSe-Ag composite for different reductions of  $\lambda$  due to increased scattering on the metallic structures. The reduction was calculated from a simple  $\delta_{te}$ -dependent relation,  $\lambda_{red} = \lambda/[1 + a\delta_{te}(1 - \delta_{te})]$ , with  $a$  chosen such that the reduction equals 5%, 10% and 20% for  $\delta_{te} = 0.5$ .

used to predict the thermoelectric performance are subject to ideal conditions and may not accurately reflect real-world scenarios. This is because they do not account for the impact of external factors such as contact resistances and inter-phase scattering. As a result, the actual performance may differ from predicted values. That being said, realistic composites with arbitrarily arranged microstructure can be approximated by a model where one component adopts a spherical shape enclosed by the other, which shows the same thermoelectric tendency as the parallel slab model [31]. Thus, the following statements should be valid in most cases.

As we have shown in this work, an enhancement of the thermoelectric properties due to a combination of a high-performance thermoelectric and a simple metal in a serial configuration is not possible without intrinsic property changes of the individual materials comprising the composite, such as interface effects. When considering the significant impact of these secondary effects on the properties of real composite materials, and the frequent use of composites to improve the figure of merit, it prompts the question of which materials are best suited for making composites.

As can be seen in Fig. 2 the total figure of merit  $zT$  stays almost constant down to a few percent of the volume fraction of the thermoelectric material when a well-conducting metal is used as the second material. This opens a gigantic playground to reduce the lattice thermal conductivity of the thermoelectric material via increased boundary scattering, as sketched in Fig. 4. Although the reduction of the thermal conductivity is shown for an oversimplified  $\delta_{te}$  relation, it is clearly visible that scattering of phonons with long mean free paths

on mesoscale-sized metallic structures will have a positive effect on the performance [23]. Hence, adding a non-soluble and highly conducting metal is a cheap and profitable strategy to achieve a larger figure of merit or reduce the amount of the thermoelectric material.

## V. CONCLUSION

We recalculated the results of Bergman and Fel [31] from a simple model while avoiding any approximations. In alignment to their model, we neglected boundary effects, such as interface electrical and thermal resistances. Despite this indisputable simple view on the matter, our results shed new light on the origin of the extreme power factor values derived for composites, which are caused by a drastic reduction of the resistance while the thermovoltage only changes moderately due to the nonuniform temperature gradient. We further elucidated the misleading meaning of the power factor by comparing measurable macroscopic quantities such as the power output to pure thermoelectric materials. We strongly advise using the robust and error-resistant figure of merit  $zT$  when comparing the performance of composites; similar to electrical resistivity and thermal conductivity, the power factor remains a well-defined quantity only for microscopically homogeneous systems. Lastly, we showed that, in theory, the best thermoelectric composite consists of a high- $zT$  thermoelectric and a simple metal with maximal thermal and electrical conductivity.

## ACKNOWLEDGMENTS

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### Appendix A: Comparison with the Bergman model

Fig. 5 compares our model with the results of Bergman and Fel [31]. The models show excellent agreement despite the different mathematical approaches. As discussed in the main article, the total power factor shows a local maximum if the incorporation of a metal into the main phase decreases the resistivity faster than the square of Seebeck coefficient. Here, this is only the case in  $(\text{Bi}_2\text{Te}_3)_{0.2}(\text{Sb}_2\text{Te}_3)_{0.8}\text{-Al}$ , where a sufficient ratio of the electrical conductivities ( $\sigma_m/\sigma_{te} = 270$ ) and thermal conductivities ( $\lambda_m/\lambda_{te} = 67.2$ ) is given. In  $\text{CoSb}_3\text{-Ni}$ , the thermal conductivities are too similar ( $\lambda_m/\lambda_{te} = 1.8$ ), which causes a significant temperature drop inside the Ni phase and makes an enhancement impossible. The  $\text{Bi}_2\text{Te}_3\text{-PbTe}$  composite instructively shows that a combination of two thermoelectrics only worsens the overall performance if not for additional scattering, diffusion or

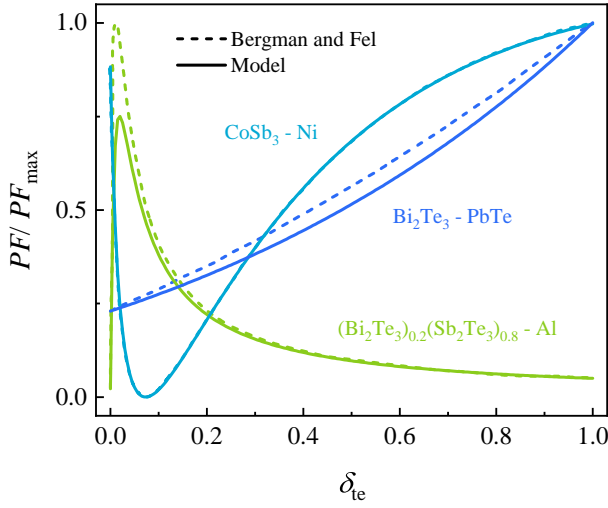


Figure 5. Comparison of the total power factor  $PF$  between the model of Bergman and Fel [31] and our model, applied on three different systems. The reference line of the  $\text{CoSb}_3\text{-Ni}$  system is not visible due to its excellent alignment with our model. The values of the individual thermoelectric properties were taken from Ref. [31].

other interrelated effects. The extremely low power factor in  $\text{CoSb}_3\text{-Ni}$  for  $\delta_{\text{te}} \approx 0.08$  is due to the opposite signs of the Seebeck coefficients, which leads to a cancellation of the opposing thermovoltages.

### Appendix B: Experimental validation

To validate the results from our model, we compared the experimental power factor of a serial  $\text{Fe}_2\text{VA}_{1.5}\text{-Cu}$  composite with the predicted values in Fig. 6. The power factor reaches  $4.5 \text{ mW/mK}^2$  at  $350 \text{ K}$  for a volume fraction of  $\text{Fe}_2\text{VA}_{1.5}$  of  $\delta_{\text{te}} = 0.25 \pm 0.1$ , a value being more than 4 times larger than that of the pristine thermoelectric. The composite was made using Spark plasma sintering with a pressure of  $50 \text{ MPa}$  and a temperature of  $1100^\circ\text{C}$ .

### Appendix C: Consideration of small interface resistances

In a composite, the interactions at the interfaces between different constituents can alter its thermoelectric performance. These interfaces can cause scattering of charge carriers, resulting in locally reduced electrical and thermal conductivity. More importantly, phonon scattering on interface structures hampers heat conduction, lowering the overall thermal conductivity but also causing a discontinuity of the temperature at the interface. Such a scenario is illustrated in Fig. 7. Similar to the derivation in the main text, the temperature drop across both the thermoelectric material and the metal can be

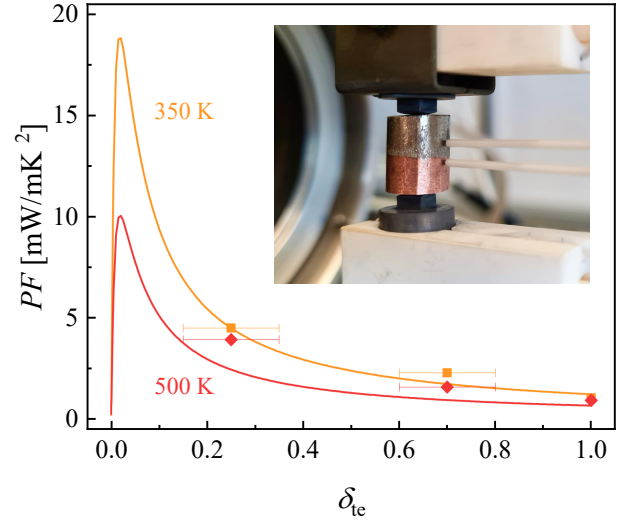


Figure 6. Comparison of the power factor of a  $\text{Fe}_2\text{VA}_{1.5}\text{-Cu}$  composite and the values predicted by the model presented in the main article. The composite was measured for 25%, 70% and 100% volume fraction of the thermoelectric material. Because of the irregular interface and uncertainty in the determination of the volume fraction due to the finite thickness of the thermocouple, an error of  $\pm 10\%$  was assumed for the volume fraction. The inset shows the experimental setup for the measurement of the system with  $\delta_{\text{te}} = 0.7$ . The thermoelectric properties of  $\text{Fe}_2\text{VA}_{1.5}$  and  $\text{Cu}$  were taken from Ref. [49] and Ref. [43, 44], respectively.

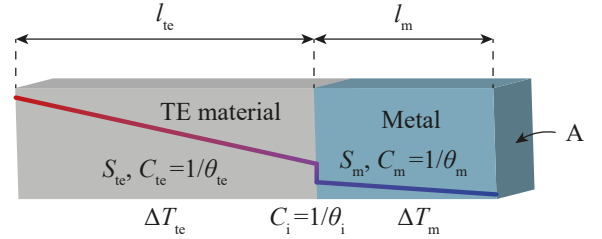


Figure 7. Schematic sketch of a serial connection of a thermoelectric material (length  $l_{\text{te}}$ ) and a metal (length  $l_{\text{m}}$ ), incorporating an interface thermal resistance. Both materials possess individual Seebeck coefficients  $S$  and thermal conductances  $C = 1/\theta$ , while the interface is characterized by an additional thermal conductance. The temperature differences across the thermoelectric material and the metal are denoted as  $\Delta T_{\text{te}}$  and  $\Delta T_{\text{m}}$ , respectively. The solid line sketches the temperature profile.

derived:

$$\Delta T_{\text{te}} = \frac{C_{\text{i}}C_{\text{m}}}{C_{\text{i}}C_{\text{te}} + C_{\text{i}}C_{\text{m}} + C_{\text{te}}C_{\text{m}}} \Delta T, \quad (\text{C1})$$

$$\Delta T_{\text{m}} = \frac{C_{\text{i}}C_{\text{te}}}{C_{\text{i}}C_{\text{te}} + C_{\text{i}}C_{\text{m}} + C_{\text{te}}C_{\text{m}}} \Delta T, \quad (\text{C2})$$



with the thermal conductances  $C_j = \lambda_j A/l_j$  and  $j = \{\text{te}, \text{m}, \text{i}\}$  denoting the thermoelectric, metal and interface, respectively.

Using the thermal resistance  $\theta_j = 1/C_j$ , these equations can be written more conveniently as

$$\begin{aligned} \Delta T_{\text{te}} &= \frac{\theta_{\text{te}}}{\theta_{\text{te}} + \theta_{\text{m}} + \theta_{\text{i}}} \Delta T \\ &= \left(1 + \frac{\theta_{\text{i}}}{\theta_{\text{te}} + \theta_{\text{m}}}\right)^{-1} \Delta T_{\text{te}}^{\text{id}} \end{aligned} \quad (\text{C3})$$

and

$$\Delta T_{\text{m}} = \left(1 + \frac{\theta_{\text{i}}}{\theta_{\text{te}} + \theta_{\text{m}}}\right)^{-1} \Delta T_{\text{m}}^{\text{id}}. \quad (\text{C4})$$

Here,  $\Delta T_{\text{te}}^{\text{id}}$  and  $\Delta T_{\text{m}}^{\text{id}}$  represent the temperature drops in the ideal system without interface resistances.

The measured thermopower is given by

$$\begin{aligned} U &= S_{\text{te}} \Delta T_{\text{te}} + S_{\text{m}} \Delta T_{\text{m}} \\ &= \left(1 + \frac{\theta_{\text{i}}}{\theta_{\text{te}} + \theta_{\text{m}}}\right)^{-1} U^{\text{id}}. \end{aligned} \quad (\text{C5})$$

As expected, the measured voltage is smaller than that of the ideal system  $U^{\text{id}}$  without interface. For a larger number  $N$  of interfaces, the Seebeck coefficient can be written as

$$S = \left(1 + \frac{N\theta_{\text{i}}}{\theta_{\text{te}} + \theta_{\text{m}}}\right)^{-1} S^{\text{id}}, \quad (\text{C6})$$

Furthermore, an equivalent trend can be observed for the overall thermal conductivity of the system. Taking into account the influence of the interface, the thermal resistance becomes

$$\theta = \theta_{\text{te}} + \theta_{\text{m}} + N\theta_{\text{i}} = \theta_{\text{te}} \left(1 + \varepsilon_{\lambda} + \frac{N\theta_{\text{i}}}{\theta_{\text{te}}}\right). \quad (\text{C7})$$

This leads to the following expression for the thermal conductivity:

$$\begin{aligned} \lambda &= \frac{\lambda_{\text{te}}}{\delta_{\text{te}} \left(1 + \varepsilon_{\lambda} + \frac{N\theta_{\text{i}}}{\theta_{\text{te}}}\right)} \\ &= \left(1 + \frac{N\theta_{\text{i}}}{\theta_{\text{te}} + \theta_{\text{m}}}\right)^{-1} \lambda^{\text{id}}. \end{aligned} \quad (\text{C8})$$

A similar impact of the interface can be found for the electrical resistivity:

$$\rho = \left(1 + \frac{N\rho_{\text{i}}}{\rho_{\text{te}} + \rho_{\text{m}}}\right) \rho^{\text{id}}, \quad (\text{C9})$$

with  $\rho_{\text{i}}$  being the electrical resistance of the interface.

In summary, the interfaces between the constituents of a composite can influence all thermoelectric properties, namely causing a reduction of the Seebeck coefficient as well as the electrical and thermal conductivity. The extent of this influence depends on the electrical and thermal resistance of the interface compared to the values of the constituents, as well as the number of interfaces, reflecting the structure of the composite.

#### Appendix D: Active cooling

Fig. 8a shows the effective thermal conductivity  $\lambda_{\text{eff}}$  of a  $\text{Bi}_2\text{Te}_3$ -Al composite for different volume fractions of the thermoelectric and compares it with Cobalt and  $\text{CePd}_3$  [48].  $\lambda_{\text{eff}}$  is significantly enhanced in metal-dominated composites. This might cause a false interpretation of measurement results. A comparison of the macroscopic quantity, the cooling power  $dQ/dt$ , reveals the inferiority of composites compared to single-phase materials (see Fig. 8b). For all volume fractions, the composite has a lower cooling efficiency despite the higher effective thermal conductivity. This shows, similar to the thermoelectric efficiency described in the main article, that a comparison of the macroscopic quantities is necessary to obtain an unbiased insight on a material's quality.

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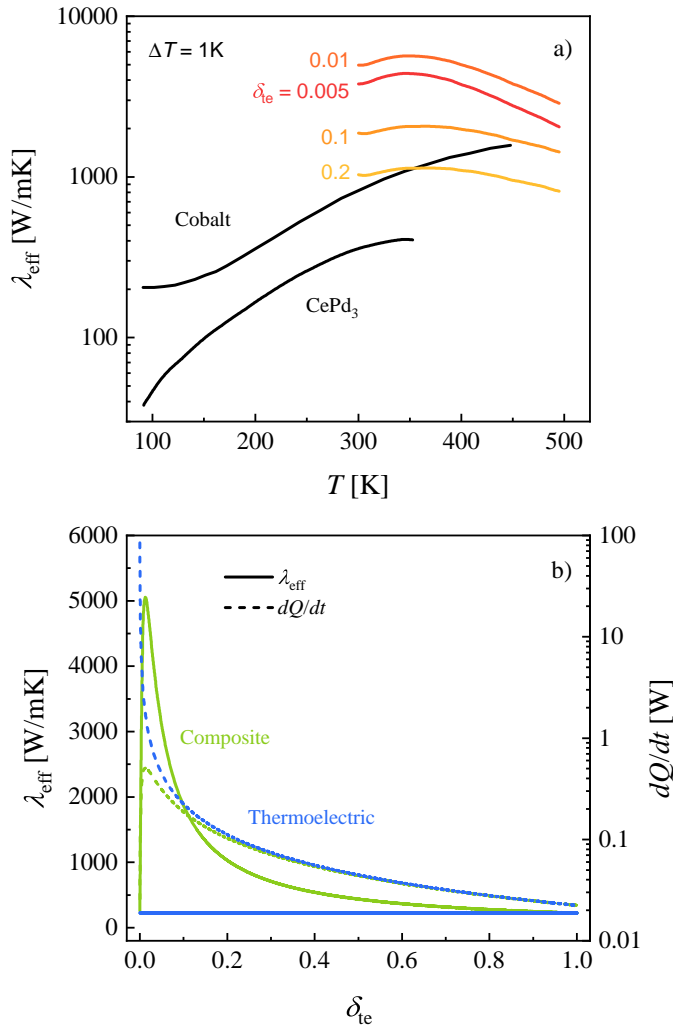


Figure 8. a) Effective thermal conductivity in dependence of the temperature  $T$  for  $\text{Bi}_2\text{Te}_3$  - Al composites with different volume fractions of the thermoelectric  $\delta_{te}$ , calculated from the formula shown in the main article. The black solid lines show reference materials [48]. b) Volume-fraction-dependent effective thermal conductivity (solid lines) and cooling power (dashed lines) of a composite and a single thermoelectric material with the length equal to the share in the composite. The properties of  $\text{Bi}_2\text{Te}_3$  and Al were taken from literature [2, 43, 44, 50].

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